

PMP8606RevB_BOM

Bill of Materials For Schematic Document [PMP8606 RevB.SchDoc]

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|-------------------|----------------------|
| Source Data From: | PMP8606 RevB.SchDoc |
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| Variant: | None |
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| Designator | Value | Description | Footprint | Quantity | Manufacturer | PartNumber | Supplier 1 | Supplier Part Number 1 | |
|----------------------------|---------|--|---|--------------------------|------------------|-------------------------|-------------------------|------------------------|----------------------|
| C1, C2 | 4700pF | CAP, CERM, 4700pF, 250VAC, +10%, COG/NP0, 2220 | 2220 | 2 | Murata | GA355DR7GF472KW01L | Digi-Key | GA355DR7GF472KW01L | |
| C3, C11 | 220uF | CAP, AL, 220uF, 450V, +/-20%, TH | CAPPR10-35x25 | 2 | Panasonic | EETHC2W221EA | Digi-Key | P11811-ND | |
| C4, C6 | 0.68uF | CAP, Film, 0.68uF, 1000VDC, +/-5%, TH | CAPRR1500W80L1800T800H1550 | 2 | Arcoltronics | 121MPE223J | | | |
| C5, C28, C42 | 1000pF | CAP, CERM, 1000pF, 630V, +10%, X7R, 1206 | 1206 | 3 | MuRata | GRM31BR7ZJ102KW01L | Digi-Key | 490-3506-1-ND | |
| C7, C8 | 0.01uF | CAP, CERM, 0.01uF, 250V, +/-10%, X7R, 0805 | 0805_HV | 2 | MuRata | GRM21BR7ZE103KW03L | Digi-Key | 490-3534-1-ND | |
| C9, C10, C23, C24 | 1000pF | CAP, CERM, 1000pF, 50V, +/-10%, X8R, 0603 | 0603 | 4 | TDK | C1608X8R1H102K | Digi-Key | 445-2501-1-ND | |
| C12 | 0.56uF | CAP, Film, 0.56uF, 630V, +/-10%, TH | CAPRR2250W80L2570T940H1970 | 1 | Panasonic | ECC-E6564KF | Digi-Key | EF6564-ND | |
| C13, C14, C18, C20, C22 | 1uF | CAP, CERM, 1uF, 50V, +/-10%, X7R, 1206 | 1206 | 5 | MuRata | GRM31MR71H105KA88L | Digi-Key | GRM31MR71H105KA88L-ND | |
| C15, C16, C17, C19, C21 | 1000uF | CAP, AL, 1000uF, 35V, +/-20%, 0.031 ohm, TH | CAPPR7.5-16X25 | 5 | Nippon Chemi-Con | EGXE350ELL102ML25S | Digi-Key | EGXE350ELL102ML25S-ND | |
| C25, C33 | 0.015uF | CAP, CERM, 0.015uF, 50V, +/-10%, X7R, 0603 | 0603 | 2 | MuRata | GRM188R71H153KA01D | Digi-Key | 490-1514-1-ND | |
| C26, C27 | 1uF | CAP, CERM, 1uF, 16V, +/-10%, X7R, 1206 | 1206 | 2 | MuRata | GRM319R71C105KA03D | Digi-Key | GRM319R71C105KA03D-ND | |
| C29, C30, C32, C36, C37 | 1uF | CAP, CERM, 1uF, 16V, +/-10%, X7R, 0603 | 0603 | 5 | MuRata | GRM188R71C105KA12D | Digi-Key | 490-3900-1-ND | |
| C31, C40 | 100pF | CAP, CERM, 100pF, 50V, +/-5%, COG/NP0, 0603 | 0603 | 2 | AVX | 06035A101JAT2A | Digi-Key | 478-1175-1-ND | |
| C34, C44 | 0.1uF | CAP, CERM, 0.1uF, 16V, +/-5%, X7R, 0603 | 0603 | 2 | AVX | 0603Y104JAT2A | Digi-Key | 478-3726-1-ND | |
| C35 | 100uF | CAP, AL, 22uF, 200V, +/-20%, 0.81386 ohm, TH | CAPPR5-10X20 | 1 | Rubycon | 16ZLH100MEFC5X11 | Digi-Key | 1189-1148-ND | |
| C38 | 0.033uF | CAP, CERM, 0.033uF, 16V, +/-10%, X7R, 0603 | 0603 | 1 | MuRata | GRM188R71C333KA01D | Digi-Key | 490-1528-1-ND | |
| C39, C43 | 1000pF | CAP, CERM, 1000pF, 16V, +/-10%, X7R, 0603 | 0603 | 2 | MuRata | GRM188R71C102KA01D | Digi-Key | GRM188R71C102KA01D-ND | |
| C41 | 2200pF | CAP, CERM, 2200pF, 50V, +/-10%, X7R, 0603 | 0603 | 1 | MuRata | GRM188R71H222KA01D | Digi-Key | 490-1500-1-ND | |
| D1 | | MURA120T3G | Diode, Ultrafast, 200V, 1A, SMA | SMA | 1 | ON Semiconductor | MURA120T3G | Digi-Key | MURA120T3GOSCT-ND |
| D2, D7 | | US1M-13-F | Diode, Ultrafast, 1000V, 1A, SMA | SMA | 2 | Diodes Inc. | US1M-13-F | Digi-Key | US1M-FDICT-ND |
| D3, D4, D6, D8, D9, D10 | | BAT54S-7-F | Diode, Schottky, 30V, 0.2A, SOT-23 | SOT-23 | 6 | Diodes Inc. | BAT54S-7-F | Digi-Key | BAT54S-FDICT-ND |
| D5 | | MBR20200CTTU | Diode, Schottky, 200V, 10A, TO220 | TO-220AB | 1 | Fairchild Semiconductor | MBR20200CTTU | Digi-Key | MBR20200CTTU-ND |
| D11 | | BZX84C9V1LT1G | Diode, Zener, 9.1V, 225mW, SOT-23 | SOT-23 | 1 | ON Semiconductor | BZX84C9V1LT1G | Digi-Key | BZX84C9V1LT1GOSCT-ND |
| HS1, HS2, HS3 | | SK482 50 | Heatsink, Vertical-mount | HEATSINK_7806B030200 | 3 | Fisher Elektronik | SK482 50 | Fisher Elektronik | SK482 50 |
| J1, J2, J3, J4 | | 15A | Terminal screw, vertical, snap-in | 7693 | 4 | Keystone | 7693 | Digi-Key | 7693K-ND |
| J5 | | 2x1 | Conn Term Block, 2POS, 3.81mm, TH | PhoenixConact_1727010 | 1 | Phoenix Contact | 1727010 | Digi-Key | 277-1148-ND |
| L1 | | 22uH | Inductor, Shielded Drum Core, WE-Prem, 22uH, 6.5A, 0.0247 ohm, SMD | WE-HCA1 | 1 | Würth Elektronik eiSos | 7443551221 | WE | 7443551221 |
| L2 | | 33uH | Resonant Inductor, Shielded, Ferrite, 33uH 2%, 2A, 0.1 ohm, TH | SER2918 | 1 | TBD | TBD | TBD | TBD |
| L3 | | 400uH | Inductor, Shielded Drum Core, WE-Superflux200, 400uH, 27A, 0.00037 ohm, SMD | WE-HC5 | 1 | Würth Elektronik eiSos | 744308040 | WE | 744308040 |
| L4 | | 33uH | Inductor, Shielded E Core, Ferrite, 33uH, 13A, 0.01 ohm, SMD | PG1096 | 1 | PULSE | PG1096 | Pulse | PG1096 |
| Q1, Q2, Q3, Q4 | | STP6N95K5 | MOSFET, N-CH, 950V, 5.4A, TO-220AB | TO-220AB | 4 | ST | STP6N95K5 | Digi-Key | STP6N95K5 |
| R1, R3 | | 12k | Resistor, Wirewound, 12kOhms, 3W, 5% | RES_1W_ERG-1SJ | 2 | Panasonic | ERG-1SJxxx | | |
| R2, R8 | | 220k | Resistor, Metal Oxide 1W Through hole, 1±% | RES_PIN-MOUNT | 2 | Mill-Max | 0338-0-15-01-15-14-10-0 | | |
| R4, R6, R13, R21, R22 | | 2.0 | RES, 2.0 ohm, 5%, 0.25W, 1206 | 1206 | 5 | Vishay-Dale | CRCW1206R00JNEA | Digi-Key | 541-2.0ECT-ND |
| R5, R7, R14, R15, R29, R30 | | 10.0k | RES, 10.0k ohm, 1%, 0.1W, 0603 | 0603 | 6 | Vishay-Dale | CRCW060310K0FKEA | Digi-Key | 541-10.0KHCT-ND |
| R9, R10, R17, R18 | | 33.0 | RES, 33.0 ohm, 1%, 0.1W, 0603 | 0603 | 4 | Yageo America | RC0603FR-0733RL | Digi-Key | 311-33.0HRCT-ND |
| R11 | | 182 | RES, 182 ohm, 1%, 0.1W, 0603 | 0603 | 1 | Yageo America | RC0603FR-07182RL | Digi-Key | 311-182HRCT-ND |
| R12 | | 174 | RES, 174 ohm, 1%, 0.25W, 1206 | 1206 | 1 | Yageo America | RC1206FR-07174RL | Digi-Key | 311-174FRCT-ND |
| R16, R39 | | 1.00k | RES, 1.00k ohm, 1%, 0.1W, 0603 | 0603 | 2 | Vishay-Dale | CRCW06031000FKEA | Digi-Key | 541-1.00KHCT-ND |
| R19 | | 0 | RES, 0 ohm, 5%, 0.25W, 1206 | 1206 | 1 | Vishay-Dale | CRCW12060000Z0EA | Digi-Key | 541-0.0ECT-ND |
| R20, R23 | | 1.20k | RES, 1.20k ohm, 1%, 0.25W, 1206 | 1206 | 2 | Yageo America | RC1206FR-071K2L | Digi-Key | 311-1.20KFRCT-ND |
| R24 | | 2.74k | RES, 2.74k ohm, 1%, 0.1W, 0603 | 0603 | 1 | Yageo America | RC0603FR-072K74L | Digi-Key | 311-2.74KFRCT-ND |
| R25, R32, R33, R42 | | 10.0k | RES, 10.0k ohm, 1%, 0.1W, 0603 | 0603 | 4 | Yageo America | RC0603FR-0710KL | Digi-Key | 311-10.0KFRCT-ND |
| R26 | | 30.9k | RES, 30.9k ohm, 1%, 0.1W, 0603 | 0603 | 1 | Yageo America | RC0603FR-0730K9L | Digi-Key | 311-30.9KFRCT-ND |
| R27 | | 22.6k | RES, 22.6k ohm, 1%, 0.25W, 1206 | 1206 | 1 | Yageo America | RC1206FR-0722K6L | Digi-Key | 311-22.6KFRCT-ND |
| R28 | | 49.9 | RES, 49.9 ohm, 1%, 0.1W, 0603 | 0603 | 1 | Vishay-Dale | CRCW0603499FKEA | Digi-Key | 541-49.9HCT-ND |
| R31 | | 1.24k | RES, 1.24k ohm, 1%, 0.1W, 0603 | 0603 | 1 | Vishay-Dale | CRCW06031K24FKEA | Digi-Key | 541-1.24KHCT-ND |
| R34 | | 2.49k | RES, 2.49k ohm, 1%, 0.1W, 0603 | 0603 | 1 | Yageo America | RC0603FR-072K49L | Digi-Key | 311-2.49KHCT-ND |
| R35, R36 | | 17.8k | RES, 17.8k ohm, 1%, 0.1W, 0603 | 0603 | 2 | Yageo America | RC0603FR-0717K8L | Digi-Key | 311-17.8KHCT-ND |
| R37 | | 29.4k | RES, 29.4k ohm, 1%, 0.1W, 0603 | 0603 | 1 | Yageo America | RC0603FR-0729K4L | Digi-Key | 311-29.4KHCT-ND |
| R38 | | 59.0k | RES, 59.0k ohm, 1%, 0.1W, 0603 | 0603 | 1 | Yageo America | RC0603FR-0759K0L | Digi-Key | 311-59.0KHCT-ND |
| R40 | | 10.0 | RES, 10.0 ohm, 1%, 0.25W, 1206 | 1206 | 1 | Vishay-Dale | CRCW120610R0FKEA | Digi-Key | 541-10.0FCT-ND |
| R41 | | 90.9k | RES, 90.9k ohm, 1%, 0.1W, 0603 | 0603 | 1 | Yageo America | RC0603FR-0790K9L | Digi-Key | 311-90.9KHCT-ND |
| R43 | | 1.58k | RES, 1.58k ohm, 1%, 0.1W, 0603 | 0603 | 1 | Yageo America | RC0603FR-071K58L | Digi-Key | 311-1.58KHCT-ND |
| T1 | | 100:1 | Transformer, Current Sense, 10 mH | XFMR_COILCRAFT_570_X_770 | 1 | Coilcraft | CS4100V-01L | Coilcraft | CS4100V-01L |
| T2, T4 | | 1800 uH | Transformer, Gate Driver | XFMR_PULSE_340X355 | 2 | Pulse | PA2002NL | Pulse | PA2002NL |
| T3 | | TBD | Transformer, Resonant Half Bridge, ±8% | XFMR_GCI_964_X_1240 | 1 | TBD | TBD | TBD | TBD |
| TP1 | | White | Test Point, TH, Miniature, White | Keystone5002 | 1 | Keystone | 5002 | Digi-Key | 5002K-ND |
| TP2 | | Red | Test Point, TH, Miniature, Red | Keystone5000 | 1 | Keystone | 5000 | Digi-Key | 5000K-ND |
| U1, U3 | | UCC27324D | IC, Dual 4A Peak High Speed Low-Side MOSFET Driver | SO8 | 2 | Texas Instruments | UCC27324D | TI | UCC27324D |
| U2 | | CNY17F3/3M | IC, Optocoupler, 70 Vceo, Viso 5000Vrms, Wide Lead Space | DIP-[6(400MIL)] | 1 | Liteon | CNY17F3/3M | TBD | CNY17F3/3M |
| U4 | | UCC28950PW | IC, Advanced Phase-Shifted PWM Controller | PW24 | 1 | Texas Instruments | UCC28950PW | TI | UCC28950PW |
| U5 | | LMV431AIMF/NOPB | Low-Voltage (1.24V) Adjustable Precision Shunt Regulators, 3-pin SOT-23 | MF03A_N | 1 | Texas Instruments | LMV431AIMF/NOPB | Digi-Key | LMV431AIMF/NOPB-ND |

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